PXIe-5644 Specifications





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PXIe-5644 Specifications

Definitions

Warranted specifications describe the performance of a model under stated operating conditions and are covered by the model warranty.

Characteristics describe values that are relevant to the use of the model under stated operating conditions but are not covered by the model warranty.

- **Typical** specifications describe the performance met by a majority of models.
- **Typical-95** specifications describe the performance met by 95% ($\approx 2\sigma$) of models with a 95% confidence.
- **Nominal** specifications describe an attribute that is based on design, conformance testing, or supplemental testing.

Specifications are **Warranted** unless otherwise noted.

Conditions

Specifications are valid under the following conditions unless otherwise noted.

- 30 minutes warm-up time.
- Calibration cycle is maintained.
- Chassis fan speed is set to High. In addition, NI recommends using slot blockers and EMC filler panels in empty module slots to minimize temperature drift.
- Calibration IP is used properly during the creation of custom FPGA bitfiles.
- Calibration Interconnect cable remains connected between CAL IN and CAL OUT front panel connectors.

• The cable connecting CAL IN to CAL OUT has not been removed or tampered with.

- Reference Clock source: Internal
- RF IN reference level: 0 dBm
- RF OUT power level: 0 dBm
- LO tuning mode: Fractional
- LO PLL loop bandwidth: Medium
- LO step size: 200 kHz
- LO frequency: 2.4 GHz
- LO source: Internal

Frequency

The following characteristics are common to both RF IN and RF OUT ports.

Frequency range	65 MHz to 6 GHz
Bandwidth ^[1]	80 MHz
Tuning resolution ^[2]	<1 Hz
LO step size	
Fractional mode	Programmable step size, 200 kHz default
Integer mode	4 MHz, 5 MHz, 6 MHz, 12 MHz, 24 MHz

Frequency Settling Time

Table 1. Maximum	Frequency Settling Time
------------------	-------------------------

Settling Time	Maximum Time (ms)			
	Low Loop Bandwidth	Medium Loop Bandwidth ^[3] (default)	High Loop Bandwidth	
≤1 × 10 ⁻⁶ of final frequency	1.1	0.95	0.38	

Settling Time	Maximum Time (ms)			
	Low Loop Bandwidth	Medium Loop Bandwidth ^[3] (default)	High Loop Bandwidth	
≤0.1 × 10 ⁻⁶ of final frequency	1.2	1.05	0.4	

The default medium loop bandwidth refers to a setting that adjusts PLL to balance tuning speed and phase noise, and it does not necessarily result in loop bandwidth between low and high.

This specification includes only frequency settling and excludes any residual amplitude settling.

Internal Frequency Reference

Accuracy	Initial adjustment accuracy \pm Aging \pm Temperature stability
Aging	±1 × 10 ⁻⁶ per year, maximum
Temperature stability	±1 × 10 ⁻⁶ , maximum
Initial adjustment accuracy	±200 × 10 ⁻⁹

Frequency Reference Input (REF IN)

Refer to the <u>REF IN</u> section.

Frequency Reference/Sample Clock Output (REF OUT)

Refer to the <u>REF OUT</u> section.

Spectral Purity

Table 2. Single Sideband Phase Noise

Frequency	Phase Noise (dBc/Hz), 20 kHz Offset (Single Sideband)			
	Low Loop Bandwidth	Medium Loop Bandwidth	High Loop Bandwidth	
<3 GHz	-99	-99	-94	
3 GHz to 4 GHz	-91	-93	-91	
>4 GHz to 6 GHz	-93	-93	-87	

Figure 1. Measured Phase Noise^[4] at 1 GHz, 2.4 GHz, and 5.8 GHz

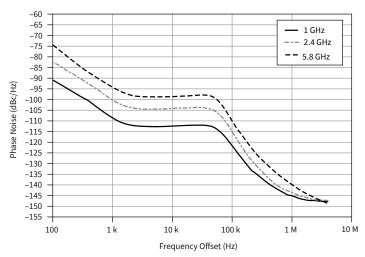
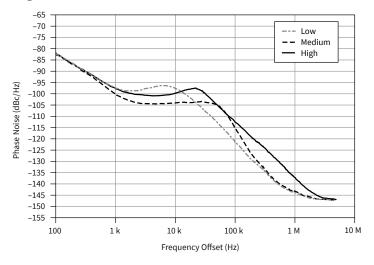


Figure 2. Measured Phase Noise^[5] at 2.4 GHz Versus Loop Bandwidth



RF Input Amplitude Range

Amplitude range	Average noise level to +30 dBm (CW RMS)
RF reference level range/resolution	≥60 dB in 1 dB nominal steps

Amplitude Settling Time

<0.1 dB of final value ^[6]	125 μs, typical
<0.5 dB of final value ^[7] , with LO retuned	300 µs

Absolute Amplitude Accuracy

Table 3.	VSA Absolute	Amplitude	Accuracy (dB)
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Center Frequency	15 °C to 35 °C		0 °C to 55 °C	
	Self-Calibration °C ± 1 °C	Self-Calibration °C ± 5 °C	Self-Calibration °C ± 1 °C	Self-Calibration °C ± 5 °C
65 MHz to	_	±0.70	—	±0.75
<375 MHz		±0.65 (95th percentile, ≈ 2σ)	_	±0.65 (95th percentile, ≈ 2σ)
	±0.34, typical	±0.50, typical	±0.36, typical	±0.55, typical
375 MHz to <2 GHz	_	±0.65	—	±0.70
		±0.55 (95th percentile, ≈ 2σ)		±0.55 (95th percentile, ≈ 2σ)
	±0.17, typical	±0.35, typical	±0.22, typical	±0.40, typical
2 GHz to <4 GHz	_	±0.70	—	±0.75
		±0.55 (95th percentile, ≈ 2σ)		±0.60 (95th percentile, ≈ 2σ)
	±0.23, typical	±0.40, typical	±0.26, typical	±0.40, typical

Center Frequency	15 °C to 35 °C		0 °C to 55 °C	
		Self-Calibration °C ± 5 °C	Self-Calibration °C ± 1 °C	Self-Calibration °C ± 5 °C
4 GHz to 6 GHz	—	±0.90	—	±0.95
	-	±0.75 (95th percentile, ≈ 2σ)	_	±0.80 (95th percentile, ≈ 2σ)
	±0.30, typical	±0.55, typical	±0.33, typical	±0.55, typical

Conditions: Reference level -30 dBm to +30 dBm; measured at 3.75 MHz offset from the configured center frequency; measurement performed after the PXIe-5644 has settled.

For reference levels <-30 dBm, absolute amplitude gain accuracy is ±0.6 dB, typical for frequencies ≤ 4 GHz, and ±0.8 dB, typical for frequencies > 4 GHz. Performance depends on signal-to-noise ratio.

This specification is valid only when the module is operating within the specified ambient temperature range and within the specified range from the last self-calibration temperature, as measured with the onboard temperature sensors.

Frequency Response

Table 4. VSA Frequency Response (dB) (Amplitude, Equalized)

RF Input Frequency	Bandwidth	Self-Calibration °C ± 5 °C
≤109 MHz	20 MHz	±1.0, typical
>109 MHz to 375 MHz	20 MHz	±0.5
	40 MHz	±1.0, typical
>375 MHz to 6 GHz	80 MHz	±0.5

Conditions: Reference level -30 dBm to +30 dBm. This specification is valid only when the module is operating within the specified ambient temperature range and within the specified range from the last self-calibration temperature, as measured with the onboard temperature sensors.

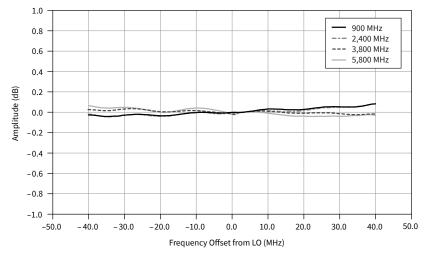
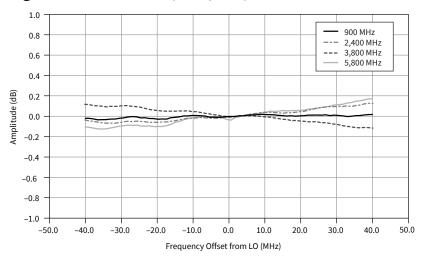


Figure 3. Measured Frequency Response, [8] 0 dBm Reference Level, Equalized

Figure 4. Measured Frequency Response,^[8]-30 dBm Reference Level, Equalized



Average Noise Density

Table 5. Average	Noise Density	(dBm/Hz)
------------------	---------------	----------

Center Frequency	Average Noise Level	
	-50 dBm Reference Level	-10 dBm Reference Level
65 MHz to 4 GHz	-159	-145
	-161, typical	-148, typical
>4 GHz to 6 GHz	-156	-144
	-158, typical	-146, typical

Center Frequency	Average Noise Level	
	-50 dBm Reference Level	-10 dBm Reference Level

Conditions: Input terminated with a 50 Ω load; 50 averages; RMS average noise level normalized to a 1 Hz noise bandwidth.

The -50 dBm reference level configuration has the inline preamplifier enabled, which represents the high sensitivity operation of the receive path.

Spurious Responses

Nonharmonic Spurs

Table 6. Nonharmonic Spurs (dBc)

Frequency	<100 kHz Offset	≥100 kHz Offset	>1 MHz Offset
65 MHz to 3 GHz	<-55, typical	<-60	<-75
>3 GHz to 6 GHz	<-55, typical	<-55	<-70
Conditions: Reference level >-30 dBm. Measured with a single tone, -1 dBr. where dBr is			

Conditions: Reference level \geq -30 dBm. Measured with a single tone, -1 dBr, where dBr is referenced to the configured RF reference level.

LO Residual Power

Table 7. VSA LO Residual Power	(dBr ^[9])
--------------------------------	-----------------------

Center Frequency	Self-Calibration °C ± 1 °C	Self-Calibration °C ± 5 °C
≤109 MHz	—	-62
	-67, typical	-67, typical
>109 MHz to 375 MHz	_	-58
	-65, typical	-61, typical
>375 MHz to 1.5 GHz	_	-53
	-58, typical	-56, typical
>1.5 GHz to 2 GHz		-47
	-58, typical	-54, typical
>2 GHz to 3 GHz	-	-52
	-58, typical	-56, typical

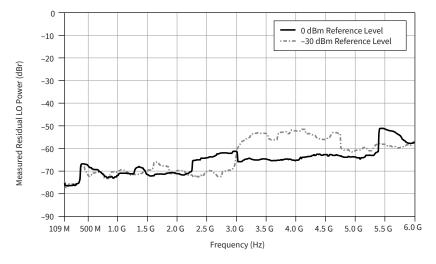
Center Frequency	Self-Calibration °C ± 1 °C	Self-Calibration °C ± 5 °C
>3 GHz to 4 GHz	-	-44
	-49, typical	-47, typical
>4 GHz to 6 GHz	-	-43
	-48, typical	-46, typical

Conditions: Reference levels -30 dBm to +30 dBm; Measured at ADC.

This specification is valid only when the module is operating within the specified ambient temperature range and within the specified range from the last self-calibration temperature, as measured with the onboard temperature sensors.

For optimal performance, NI recommends running self-calibration when the PXIe-5644 temperature drifts ± 5 °C from the temperature at the last self-calibration. For temperature changes >±5 °C from self-calibration, LO residual power is -35 dBr.

Figure 5. VSA LO Residual Power,^[10] Typical



Residual Sideband Image

Table 8. VSA Residual Sideband Image, 80 MHz Bandwidth (dBc)

Center Frequency	Self-Calibration °C ± 1 °C	Self-Calibration °C ± 5 °C
≤109 MHz	-	-40
	-60, typical	-50, typical
>109 MHz to 500 MHz	_	-40

Center Frequency	Self-Calibration °C ± 1 °C	Self-Calibration °C ± 5 °C
	-50, typical	-45, typical
>500 MHz to 3 GHz	_	-65
	-75, typical	-70, typical
>3 GHz to 5 GHz	-	-55
	-70, typical	-60, typical
>5 GHz to 6 GHz	_	-60
	-70, typical	-65, typical

Conditions: Reference levels -30 dBm to +30 dBm.

This specification describes the maximum residual sideband image within an 80 MHz bandwidth at a given RF center frequency. Bandwidth is restricted to 20 MHz for LO frequencies ≤ 109 MHz.

This specification is valid only when the module is operating within the specified ambient temperature range and within the specified range from the last self-calibration temperature, as measured with the onboard temperature sensors.

For optimal performance, NI recommends running self-calibration when the PXIe-5644 temperature drifts ± 5 °C from the temperature at the last self-calibration. For temperature changes >± 5 °C from self-calibration, residual image suppression is -40 dBc.

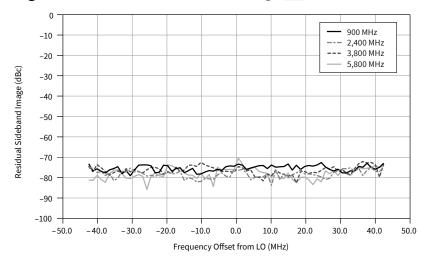


Figure 6. VSA Residual Sideband Image, ^[11] 0 dBm Reference Level, Typical

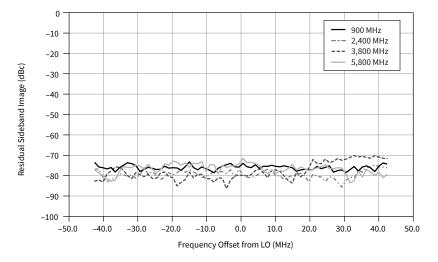


Figure 7. VSA Residual Sideband Image, [11] -30 dBm Reference Level, Typical

Third-Order Input Intermodulation

Table 9. Third-Order Input Intercept Point (IIP₃), -5 dBm Reference Level, Typical

Frequency Range	IIP ₃ (dBm)
65 MHz to 1.5 GHz	19
>1.5 GHz to 6 GHz	20
Conditions: Two -10 dBm tones, 700 kHz apart at RF IN; reference level: -5 dBm<4 GHz, -2 dBm reference level otherwise; nominal noise floor: -148 dBm/Hz for -5 dBm reference level, -145 dBm/Hz for -2 dBm reference level.	

Table 10. Third-Order Input Intercept Point (IIP₃), -20 dBm Reference Level, Typical

Frequency Range	IIP ₃ (dBm)
65 MHz to 200 MHz	9
>200 MHz to 2 GHz	11
>2 GHz to 3.75 GHz	8
>3.75 GHz to 4.25 GHz	6
>4.25 GHz to 5 GHz	4
>5 GHz to 6 GHz	1

Frequency Range	IIP ₃ (dBm)
Conditions: Two -25 dBm tones, 700 kHz apart at floor: -157 dBm/Hz.	RF IN; reference level: -20 dBm; nominal noise

Second-Order Input Intermodulation

Table 11. Second-Order Input Intercept Point (IIP₂), -2 dBm Reference Level, Typical^[12]

Frequency Range	IIP ₂ (dBm)
65 MHz to 1.5 GHz	67
>1.5 GHz to 4 GHz	58
>4 GHz to 6 GHz	52

RF Output

Power Range

Table 12. Power Range

Output Type	Frequency	Power Range	
CW	<4 GHz	Noise floor to +10 dBm, average power ^[13]	Noise floor to +15 dBm, average power, nominal
	≥4 GHz	Noise floor to +7 dBm, average power ^[13]	Noise floor to +12 dBm, average power, nominal
Modulated ^[14]	<4 GHz	Noise floor to +6 dBm, average power	_
	≥4 GHz	Noise floor to +3 dBm, average power	
Output attenuator resolution		2 dB, nominal	
Digital attenuation resolution ^[15]		0.1 dB or better	

Related concepts:

• <u>Refer to the Considering Average Power and Crest Factor topic of the NI RF</u> <u>Vector Signal Transceivers Help for more information about modulated signal</u> <u>power.</u>

Amplitude Settling Time

0.1 dB of final value ^[16]	50 μs
0.5 dB of final value $\frac{[17]}{}$, with LO retuned	300 µs

Output Power Level Accuracy

Table 13. Output Power Level Accuracy (dB)

Center Frequency	15 °C to 35 °C		0 °C to 55 °C	
	Self- Calibration °C ± 1 °C	Self- Calibration °C ± 5 °C	Self- Calibration °C ± 1 °C	Self- Calibration °C ± 5 °C
65 MHz to	—	±0.70	—	±0.90
<109 MHz		±0.55 (95th percentile, ≈ 2σ)	—	±0.65 (95th percentile, ≈ 2σ)
	±0.26, typical	±0.40, typical	±0.36, typical	±0.50, typical
109 MHz to		±0.75	±0.36, typical	±0.90
<270 MHz <u>^[18]</u>		±0.60 (95th percentile; ≈ 2σ)		±0.70 (95th percentile; ≈ 2σ)
		±0.45, typical		±0.55, typical
270 MHz to	—	±0.70	-	±0.90
<375 MHz	-	±0.55 (95th percentile, ≈ 2σ)		±0.65 (95th percentile, ≈ 2σ)
	±0.26, typical	±0.40, typical	±0.36, typical	±0.50, typical
375 MHz to <2 GHz	-	±0.75	-	±0.90
		±0.55 (95th percentile, ≈ 2σ)	—	±0.65 (95th percentile, ≈ 2σ)

Center Frequency	15 °C to 35 °C		0 °C to 55 °C	
	Self- Calibration °C ± 1 °C	Self- Calibration °C ± 5 °C	Self- Calibration °C ± 1 °C	Self- Calibration °C ± 5 °C
	±0.26, typical	±0.40, typical	±0.36, typical	±0.50, typical
2 GHz to <4 GHz	—	±0.75	_	±0.90
	—	±0.60 (95th percentile, ≈ 2σ)	_	±0.70 (95th percentile, ≈ 2σ)
	±0.26, typical	±0.40, typical	±0.36, typical	±0.50, typical
4 GHz to 6 GHz		±1.00	-	±1.15
	_	±0.80 (95th percentile, ≈ 2σ)	_	±0.90 (95th percentile, ≈ 2σ)
	±0.28, typical	±0.40, typical	±0.38, typical	±0.60, typical

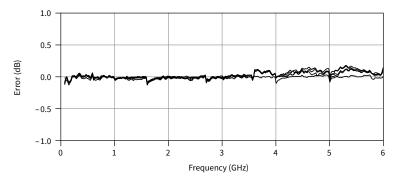
Conditions: CW average power -70 dBm to +10 dBm.

For power <-70 dBm, highly accurate generation can be achieved using digital attenuation, which relies on DAC linearity.

The absolute amplitude accuracy is measured at 3.75 MHz offset from the configured center frequency. The absolute amplitude accuracy measurements are made after the PXIe-5644 has settled.

This specification is valid only when the module is operating within the specified ambient temperature range and within the specified range from the last self-calibration temperature, as measured with the onboard temperature sensors.

Figure 8. Relative Power Accuracy, -40 dBm to 10 dBm, 10 dB Steps, Typical



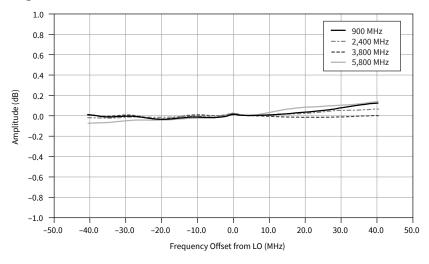
Frequency Response

Table 14. VSG Frequency Response (dB) (Amplitude, Equalized)

Output Frequency	Bandwidth	Self-Calibration °C ± 5 °C
≤109 MHz	20 MHz	±1.0, typical
>109 MHz to 375 MHz	20 MHz	±0.5
	40 MHz	±1.0, typical
>375 MHz to 6 GHz	80 MHz	±0.5

For this specification, frequency refers to the RF output frequency. This specification is valid only when the module is operating within the specified ambient temperature range and within the specified range from the last self-calibration temperature, as measured with the onboard temperature sensors.

Figure 9. VSG Measured Frequency Response^[19]



Output Noise Density

Center Frequency	Power Setting		
_	-30 dBm	0 dBm	10 dBm
65 MHz to 500 MHz	-	-	-136
	-168, typical	-150 , typical	-140, typical
>500 MHz to 2.5 GHz	-168, typical	-150	-141

Center Frequency	Power Setting		
	-30 dBm	0 dBm	10 dBm
>2.5 GHz to 3.5GHz	-168, typical	-149	-139
>3.5 GHz to 6 GHz	-165, typical	-147	-136

Conditions: Averages: 200 sweeps; baseband signal attenuation: -40 dB; noise measurement frequency offset: 4 MHz relative to output tone frequency.

Spurious Responses

Harmonics

Table 16.	Second Harmonic Level (dBc)
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Fundamental Frequency	23 °C ± 5 °C	0 °C to 55 °C
65 MHz to 3.5 GHz	-27	-24.8
	-29.5, typical	-27.2, typical
>3.5 GHz to 4.5 GHz	-26.3	-24
	-28.9, typical	-26.6, typical
>4.5 GHz to 6 GHz	-28.9	-26.6
	-33.3, typical	-31, typical

Conditions: Measured using 1 MHz baseband signal -1 dBFS; fundamental signal measured at +6 dBm CW; second harmonic levels nominally <-30 dBc for fundamental output levels of ≤5 dBm.

Note Higher order harmonic suppression is degraded in the range of 109 MHz to 270 MHz, and third harmonic performance is shown in the following figure. For frequencies outside the range of 109 MHz to 270 MHz, higher order harmonic distortion is equal to or better than the second harmonic level as specified in the previous table.

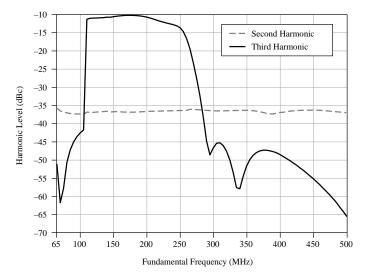


Figure 10. Harmonic Level, [20] 65 MHz to 500 MHz, Measured

Nonharmonic Spurs

Table 17. Nonharmonic Spurs (dBc)

Frequency	<100 kHz Offset	≥100 kHz Offset	>1 MHz Offset
65 MHz to 3 GHz	<-55, typical	<-62	<-75
>3 GHz to 6 GHz	<-55, typical	<-57	<-70
Conditions: Output full scale level ≥-30 dBm. Measured with a single tone at -1 dBFS.			

Third-Order Output Intermodulation

Table 18. Third-Order Output Intermodulation Distortion (IMD₃) (dBc), 0 dBm Tones

Fundamental Frequency	Baseband DAC: -2 dBFS	Baseband DAC: -6 dBFS
65 MHz to 1 GHz	-55, typical	-60, typical
>1 GHz to 3 GHz	-53, typical	-53, typical
>3 GHz to 5 GHz	-49, typical	-50, typical
>5 GHz to 6 GHz	-44, typical	-45, typical

Fundamental Frequency	Baseband DAC: -2 dBFS	Baseband DAC: -6 dBFS
Conditions: Two 0 dBm tones, 50	00 kHz apart at RF OUT.	
RF gain applied to achieve the desired output power per tone.		

Table 19. Third-Order Output Intermodulation Distortion	(IMD ₃) (dBc), -6 dBm Tones
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Fundamental Frequency	Baseband DAC: -2 dBFS	Baseband DAC: -6 dBFS
65 MHz to 1.5 GHz	-50	-59
	-54, typical	-62, typical
>1.5 GHz to 3.5 GHz	-54	-59
	-57, typical	-62, typical
>3.5 GHz to 5 GHz	-50	-55
	-53, typical	-58, typical
>5 GHz to 6 GHz	-47	-51
	-50, typical	-54, typical
Conditions: Two -6 dBm tones, 500 kHz apart at RF OUT.		
RF gain applied to achieve the desired output power per tone.		

Table 20. Third-Order Output Intermodulation Distortion (IMD₃) (dBc), -36 dBm Tones

Fundamental Frequency	Baseband DAC: -2 dBFS	Baseband DAC: -6 dBFS
65 MHz to 200 MHz	-52	-57
	-54, typical	-60, typical

Fundamental Frequency	Baseband DAC: -2 dBFS	Baseband DAC: -6 dBFS
>200 MHz to 6 GHz	-52	-55
	-54, typical	-58, typical
Conditions: Two -36 dBm tones, 500 kHz apart at RF OUT.		
RF gain applied to achieve the desired output power per tone.		

LO Residual Power

Table 21. VS	G LO Residual	Power	(dBc)
--------------	---------------	-------	-------

Self-Calibration °C ± 1 °C	Self-Calibration °C ± 5 °C
-	-50
-57, typical	-55, typical
_	-42
-47, typical	-45, typical
-	-55
-62, typical	-60, typical
-	-54
-60, typical	-58, typical
-	-47
-53, typical	-51, typical
-	-52
-57, typical	-55, typical
-	-51
-60, typical	-56, typical
-	-47
-56, typical	-52, typical
	57, typical47, typical62, typical60, typical53, typical57, typical60, typical60, typical60, typical60, typical60, typical60, typical60, typical60, typical

Conditions: Configured power levels -50 dBm to +10 dBm.

	1	
Center Frequency	Self-Calibration °C ± 1 °C	Self-Calibration °C ± 5 °C
This specification is valid only when the module is operating within the specified ambient temperature range and within the specified range from the last self-calibration temperature, as measured with the onboard temperature sensors.		
For optimal performance, NI recommends running self-calibration when the PXIe-5644		

For optimal performance, NI recommends running self-calibration when the PXIe-5644 temperature drifts \pm 5 °C from the temperature at the last self-calibration. For temperature changes > \pm 5 °C from self-calibration, LO residual power is -40 dBc.

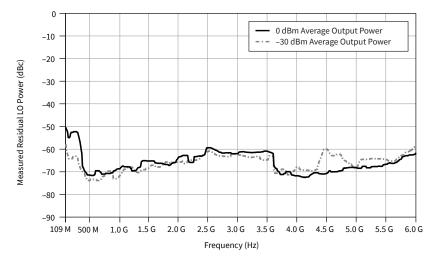


Figure 11. VSG LO Residual Power,^[21]109 MHz to 6 GHz, Typical

Center Frequency	Self-Calibration °C ± 5 °C
≤109 MHz	
	-49, typical
>109 MHz to 375 MHz	-45
	-50, typical
>375 MHz to 2 GHz	-55
	-60, typical
>2 GHz to 3 GHz	-50
	-53, typical
>3 GHz to 4 GHz	-55
	-58, typical
>4 GHz to 5 GHz	-

Center Frequency	Self-Calibration °C ± 5 °C
	-40, typical
>5 GHz to 6 GHz	-43
	-45, typical

Conditions: Configured power levels < -50 dBm to -70 dBm.

This specification is valid only when the module is operating within the specified ambient temperature range and within the specified range from the last self-calibration temperature, as measured with the onboard temperature sensors.

For optimal performance, NI recommends running self-calibration when the PXIe-5644 temperature drifts ± 5 °C from the temperature at the last self-calibration. For temperature changes >± 5 °C from self-calibration, LO residual power is -40 dBc.

Residual Sideband Image

Center Frequency	Self-Calibration °C ± 1 °C	Self-Calibration °C ± 5 °C
≤109 MHz	_	-40
	-55, typical	-45, typical
>109 MHz to 375 MHz	-	-
	-45, typical	-40, typical
>375 MHz to 2 GHz	_	-60
	-70, typical	-65, typical
>2 GHz to 4 GHz	_	-50
	-65, typical	-55, typical
>4 GHz to 6 GHz	_	-40
	-70, typical	-50, typical

Table 23. VSG Residual Sideband Image (dBc), 80 MHz Bandwidth

Conditions: Configured power levels -50 dBm to +10 dBm.

This specification describes the maximum residual sideband image within an 80 MHz bandwidth at a given RF center frequency. Bandwidth is restricted to 20 MHz for LO frequencies ≤ 109 MHz.

Center Frequency	Self-Calibration $^{\circ}C \pm 1 ^{\circ}C$	Self-Calibration °C ± 5 °C
This specification is valid only when the module is operating within the specified ambient		
temperature range and within the specified range from the last self-calibration temperature, as		
measured with the onboard temperature sensors.		

For optimal performance, NI recommends running self-calibration when the PXIe-5644 temperature drifts \pm 5 °C from the temperature at the last self-calibration. For temperature changes > \pm 5 °C from self-calibration, residual image suppression is -40 dBc.

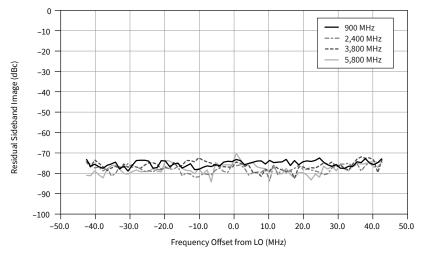
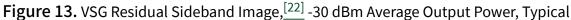
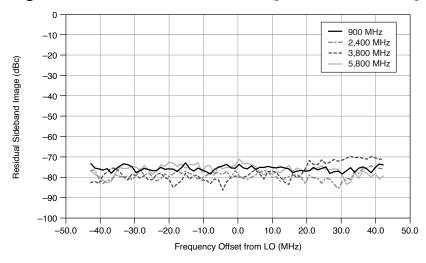


Figure 12. VSG Residual Sideband Image, ^[22] 0 dBm Average Output Power, Typical



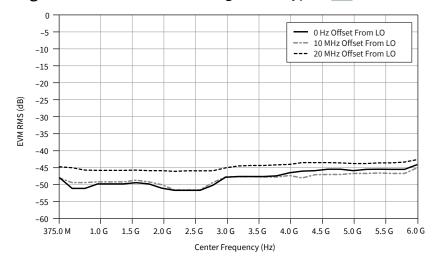


Error Vector Magnitude (EVM)

VSA EVM

20 MHz bandwidth 64-QAM-40 dB, typicalEVM[23]375 MHz to 6 GHz

Figure 14. VSA Error Vector Magnitude, Typical^[24]



VSG EVM

20 MHz bandwidth 64-QAM	-40 dB, typical	
EVM ^[25] 375 MHz to 6 GHz		

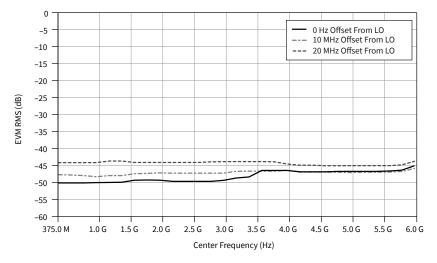


Figure 15. RMS EVM (dB) versus Measured Average Power (dBm), Typical [26]

Application-Specific Modulation Quality

Typical performance assumes the PXIe-5644 is operating within ± 5 °C of the previous self-calibration temperature, and that the ambient temperature is 0 °C to 55 °C.

WLAN 802.11ac

OFDM[27]	-45 EVM (rms) dB, typical
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WLAN 802.11n

Table 24. 802.11n OFDM EVM (rms) (dB), Typical

Frequency	20 MHz Bandwidth	40 MHz Bandwidth
2,412 MHz	-50	-50
5,000 MHz	-48	-46
Conditions: RF OUT loopback to RF IN; average power: -10 dBm; reference level: auto-leveled based on real-time average power measurement; 20 packets; 3/4 coding rate; 64 QAM.		

WLAN 802.11a/g/j/p

Table 25. 802.11a/g/j/p OFDM EVM (rms) (dB), Typical

Frequency	20 MHz Bandwidth
2,412 MHz	-53
5,000 MHz	-50
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Conditions: RF OUT loopback to RF IN; average power: -10 dBm; reference level: auto-leveled based on real-time average power measurement; 20 packets; 3/4 coding rate; 64 QAM.

WLAN 802.11g

Table 26. 802.11g DSSS-OFDM EVM (rms) (dB), Typical

Frequency	20 MHz Bandwidth
2,412 MHz	-53
5,000 MHz	-50

Conditions: RF OUT loopback to RF IN; average power: -10 dBm; reference level: auto-leveled based on real-time average power measurement; 20 packets; 3/4 coding rate; 64 QAM.

WLAN 802.11b/g

DSSS ^[28]	-48 EVM (rms) dB, typical	
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LTE

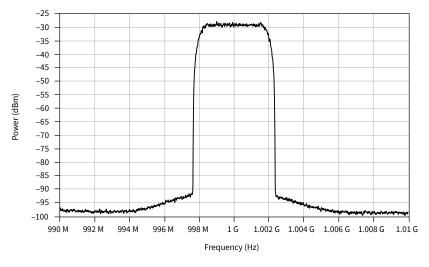
Table 27. SC-FDMA^[29] (Uplink FDD) EVM (rms) (dB), Typical

Frequency	5 MHz Bandwidth	10 MHz Bandwidth	20 MHz Bandwidth
700 MHz	-56	-56	-54
900 MHz	-55	-55	-53
1,430 MHz	-54	-54	-53
1,750 MHz	-51	-50	-50
1,900 MHz	-51	-50	-50

Frequency	5 MHz Bandwidth	10 MHz Bandwidth	20 MHz Bandwidth
2,500 MHz	-50	-49	-49

WCDMA

Figure 16. WCDMA Measured Spectrum^[30] (ACP)



Baseband Characteristics

Analog-to-digital converters (ADCs)		
Resolution	16 bits	
Sample rate ^[31]	120 MS/s	
I/Q data rate ^[32]	1.84 kS/s to 120 MS/s	
Digital-to-analog converters (DACs)		
Resolution	16 bits	
Sample rate ^[33]	120 MS/s	
I/Q data rate ^[34]	1.84 kS/s to 120 MS/s	

Onboard FPGA

FPGA	Xilinx Virtex-6 LX195T
LUTs	124,800
Flip-flops	249,600
DSP48 slices	640
Embedded block RAM	12,384 kbits
Data transfers	DMA, interrupts, programmed I/O
Number of DMA channels	16

Onboard DRAM

Memory size	2 banks, 256 MB per bank
Theoretical maximum data rate	2.1 GB/s per bank

Onboard SRAM

Memory size	2 MB
Maximum data rate (read)	40 MB/s
Maximum data rate (write)	36 MB/s

Front Panel I/O

RF IN

Connector	SMA (female)
Input impedance	50 Ω, nominal, AC coupled
Maximum DC input voltage without damage	8 V
Absolute maximum input power ^[35]	+33 dBm (CW RMS)

Input Return Loss (Voltage Standing Wave Ratio (VSWR))

Table 28. Input Return Loss (dB) (VSWR)

Frequency	Typical	
$109 \text{ MHz} \le f \le 2.4 \text{ GHz}$	15.5 (1.40:1)	
2.4 GHz \leq f < 4 GHz	12.7 (1.60:1)	
$4 \text{ GHz} \le f \le 6 \text{ GHz}$ 11.0 (1.78:1)		
Return loss for frequencies <109 MHz is typically better than 14 dB (VSWR <1.5:1).		

RF OUT

Connector	SMA (female)	
Output impedance	50 Ω, nominal, AC coupled	
Absolute maximum reverse power ^[36]		
<4 GHz	+33 dBm (CW RMS)	
≥4 GHz	+30 dBm (CW RMS)	

Output Return Loss (VSWR)

Table 29. Output Return Loss (dB) (VSWR)

Frequency	Typical	
$109 \text{ MHz} \le f \le 2 \text{ GHz}$	19.0 (1.25:1)	
$2 \text{ GHz} \le f \le 5 \text{ GHz}$	14.0 (1.50:1)	
$5 \text{ GHz} \le f \le 6 \text{ GHz}$ 11.0 (1.78:1)		
Return loss for frequencies < 109 MHz is typically better than 20 dB (VSWR < 1.22:1).		

CAL IN, CAL OUT

Connector	SMA (female)
Impedance	50 Ω, nominal

Caution Do not disconnect the cable that connects CAL IN to CAL OUT. Removing the cable from or tampering with the CAL IN or CAL OUT front panel connectors voids the product calibration and specifications are no longer warranted.

LO OUT (RF IN 0 and RF OUT 0)

Connectors	SMA (female)	
Frequency range ^[37]	65 MHz to 6 GHz	
Power		
LO OUT (RF IN 0) 65 MHz to 6 GHz	0 dBm ±2 dB, typical	
LO OUT (RF OUT 0)		
65 MHz to 3.6 GHz	0 dBm ±2 dB, typical	

≥3.6 GHz to 6 GHz	3 dBm ±2 dB, typical	
Output power resolution	0.25 dB, nominal	
Output impedance	50 Ω, nominal, AC coupled	
Output return loss	>11.0 dB (VSWR <1.8:1), typical	
Output isolation (state: disabled)		
<2.5 GHz tuned LO	-45 dBc, nominal	
≥2.5 GHz tuned LO	-35 dBc, nominal	

LO IN (RF IN 0 and RF OUT 0)

Connectors	SMA (female)
Frequency range ^[38]	65 MHz to 6 GHz
Expected input power	
LO IN (RF IN 0) 65 MHz to 6 GHz	0 dBm ±3 dB, nominal
LO IN (RF OUT 0)	
65 MHz to 3.6 GHz	0 dBm ±3 dB, nominal
≥3.6 GHz to 6 GHz	3 dBm ±1 dB, nominal
Input impedance	50 Ω, nominal, AC coupled
Input return loss	>11.7 dB (VSWR <1.7:1), typical
Absolute maximum power	+15 dBm

Maximum DC voltage	±5 VDC

REF IN

Connector	SMA (female)
Frequency	10 MHz
Tolerance ^[39]	$\pm 10 \times 10^{-6}$
Amplitude	·
Square	0.7 $V_{pk\text{-}pk}$ to 5.0 $V_{pk\text{-}pk}$ into 50 $\Omega,$ typical
Sine ^[40]	1.4 $V_{pk\text{-}pk}$ to 5.0 $V_{pk\text{-}pk}$ into 50 $\Omega,$ typical
Input impedance	50 Ω, nominal
Coupling	AC

REF OUT

Connector	SMA (female)
Frequency	
Reference Clock ^[41]	10 MHz, nominal
Sample Clock	120 MHz, nominal
Amplitude	1.65 Vpk-pk into 50 Ω, nominal
Output impedance	50 Ω, nominal

Coupling	AC

PFI 0

Connector	SMA (female)
Voltage levels ^[42]	
Absolute maximum input range	-0.5 V to 5.5 V
V _{IL}	0.8 V
V _{IH}	2.0 V
V _{OL}	0.2 V with 100 μA load
V _{OH}	2.9 V with 100 μA load
Input impedance	10 kΩ, nominal
Output impedance	50 Ω, nominal
Maximum DC drive strength	24 mA
Minimum required direction change latency ^[43]	48 ns + 1 clock cycle

DIGITAL I/O

Connector	VHDCI

Signal	Direction	Port Width	
DIO <2320>	Bidirectional, per port	4	
DIO <1916>	Bidirectional, per port	4	
DIO <1512>	Bidirectional, per port	4	
DIO <118>	Bidirectional, per port	4	
DIO <74>	Bidirectional, per port	4	
DIO <30>	Bidirectional, per port	4	
PFI 1	Bidirectional	1	
PFI 2	Bidirectional	1	
Clock In	Input	1	
Clock Out	Output	1	

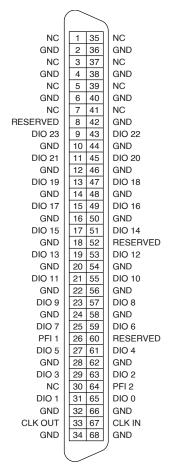
Table 30. DIGITAL I/O Signal Characteristics

Voltage levels^[44]

Absolute maximum input range	-0.5 V to 4.5 V	
V _{IL}	0.8 V	
V _{IH}	2.0 V	
V _{OL}	0.2 V with 100 μA load	
V _{OH}	2.9 V with 100 μA load	
Input impedance		
DIO <230>, CLK IN	10 kΩ, nominal	
PFI 1, PFI 2	100 kΩ pull up, nominal	
Output impedance	50 Ω, nominal	
Maximum DC drive strength	12 mA	

Minimum required direction change latency[45]	48 ns + 1 clock cycle
Maximum toggle rate	125 MHz, typical

Figure 17. DIGITAL I/O VHDCI Connector



Power Requirements

Table 31. Power Requirements

Voltage (V _{DC})	Typical Current (A)	Maximum Current (A)
+3.3	4.9	5.3
+12	3.3	4.2
Power is 56 W, typical. Consumption is from both PXI Express backplane power connectors.		

Calibration

Interval	1 year

Note For the two-year calibration interval, add 0.2 dB to one-year specifications for <u>Absolute Amplitude Accuracy</u>, RF input <u>Frequency</u> <u>Response</u>, <u>Output Power Level Accuracy</u>, and RF output <u>Frequency</u> <u>Response</u>.

Physical Characteristics

PXIe-5644 module	3U, three slot, PXI Express module 6.1 cm × 12.9 cm × 21.1 cm (2.4 in × 5.6 in × 8.3 in)
Weight	1,360 g (48.0 oz)

Environment

Maximum altitude	2,000 m (800 mbar) (at 25 °C ambient temperature)
Pollution Degree	2

Indoor use only.

Operating Environment

Ambient temperature range	0 °C to 55 °C
Relative humidity range	10% to 90%, noncondensing

Storage Environment

Ambient temperature range	-40 °C to 71 °C
Relative humidity range	5% to 95%, noncondensing

Shock and Vibration

Operating shock	30 g peak, half-sine, 11 ms pulse
Random vibration	
Operating	5 Hz to 500 Hz, 0.3 g _{rms}
Nonoperating	5 Hz to 500 Hz, 2.4 g _{rms}

Compliance and Certifications

Safety Compliance Standards

This product is designed to meet the requirements of the following electrical equipment safety standards for measurement, control, and laboratory use:

- IEC 61010-1, EN 61010-1
- UL 61010-1, CSA C22.2 No. 61010-1

Note For safety certifications, refer to the product label or the <u>Product</u> <u>Certifications and Declarations</u> section.

Electromagnetic Compatibility

This product meets the requirements of the following EMC standards for electrical equipment for measurement, control, and laboratory use:

- EN 61326-1 (IEC 61326-1): Class A emissions; Basic immunity
- EN 55011 (CISPR 11): Group 1, Class A emissions
- EN 55022 (CISPR 22): Class A emissions
- EN 55024 (CISPR 24): Immunity
- AS/NZS CISPR 11: Group 1, Class A emissions
- AS/NZS CISPR 22: Class A emissions
- FCC 47 CFR Part 15B: Class A emissions
- ICES-001: Class A emissions

Note In the United States (per FCC 47 CFR), Class A equipment is intended for use in commercial, light-industrial, and heavy-industrial locations. In Europe, Canada, Australia, and New Zealand (per CISPR 11), Class A equipment is intended for use only in heavy-industrial locations.

Note Group 1 equipment (per CISPR 11) is any industrial, scientific, or medical equipment that does not intentionally generate radio frequency energy for the treatment of material or inspection/analysis purposes.

Note For EMC declarations, certifications, and additional information, refer to the <u>Product Certifications and Declarations</u> section.

Product Certifications and Declarations

Refer to the product Declaration of Conformity (DoC) for additional regulatory compliance information. To obtain product certifications and the DoC for NI products, visit <u>ni.com/product-certifications</u>, search by model number, and click the appropriate link.

Environmental Management

NI is committed to designing and manufacturing products in an environmentally responsible manner. NI recognizes that eliminating certain hazardous substances from our products is beneficial to the environment and to NI customers.

For additional environmental information, refer to the **Engineering a Healthy Planet** web page at <u>ni.com/environment</u>. This page contains the environmental regulations and directives with which NI complies, as well as other environmental information not included in this document.

EU and UK Customers

• X Waste Electrical and Electronic Equipment (WEEE)—At the end of the product life cycle, all NI products must be disposed of according to local laws and regulations. For more information about how to recycle NI products in your region, visit <u>ni.com/environment/weee</u>.

电子信息产品污染控制管理办法(中国 RoHS)

• ●●● 中国 RoHS— NI 符合中国电子信息产品中限制使用某些有害物质 指令(RoHS)。关于 NI 中国 RoHS 合规性信息,请登录 ni.com/environment/ rohs_china。(For information about China RoHS compliance, go to ni.com/ environment/rohs_china.)